

RoHS Compliant

Halogen Free

6-0.60±0.10 4.50±0.10 0.90±0.08

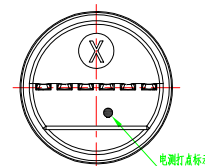
6个焊盘要求预上锡
(0.15+0.20/-0.05mm)

2.67±0.10 1.07±0.10 14.95±0.15 15.20±0.15 16.20±0.15

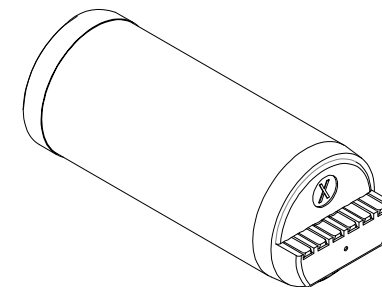
6.42±0.05

0.30±0.15 0.650±0.05 0.360±0.04

1.10±0.05 0.570±0.10



电测打点标示



3D VIEW

TABLE 2:

P/N	color
J441J06JA26ZL2	Black
J441J06JA26NL2	White

NOTES:

- MATERIAL: SEE "TABLE 1";
- FINISH: SEE "TABLE 1";
- ELECTRICAL:
 - VOLTAGE RATING: 30 VDC RMS;
 - CURRENT RATING: 0.5 AMP;
 - CONTACT RESISTANCE: 50mΩ Max.
 - INSULATION RESISTANCE: 100 MΩ Min., 500VDC.(Initial), 50 MΩ Min., 500VDC.(After Humidity test);
 - WITHSTAND VOLTAGE: 500 VAC RMS 50(60)Hz, 1 minute;
- MECHANICAL:
 - MATING FORCE: INITIAL 0.3~3.0Kgf, AFTER 0.3~3.0Kgf
 - UNMATING FORCE: INITIAL 0.3~3.0Kgf, AFTER 0.3~3.0Kgf
 - OPERATING LIFE: 5000 CYCLES MIN.;
- ENVIRONMENTAL:
 - OPERATION: -30°C~+80°C.

TABLE 1:

12	Plastics Ring	1	HIGH TEMP	White	UL94 V-0
11	Spring	1	Stainless steel	Nickel	T=0.20mm
10	Ring	1	C3604	Nickel	
9	Insulator	1	HIGH TEMP	Black	UL94 V-0
8	Cover	1	NYLON	White	UL94 V-0
7	Housing	1	NYLON	White/Black	UL94 V-0
6	Contact_6	1	COPPER ALLOY	GOLD G/F ON CONTACT AREA, GOLD G/F ON SOLDER AREA, ALL OVER NI 50u" MIN	T=0.20mm
5	Contact_5	1	COPPER ALLOY		T=0.20mm
4	Contact_4	1	COPPER ALLOY		T=0.20mm
3	Contact_3	1	COPPER ALLOY		T=0.20mm
2	Contact_2	1	COPPER ALLOY		T=0.20mm
1	Contact_1	1	COPPER ALLOY		T=0.20mm
NO.	PART NAME	QTY	MATERIAL	DESCRIPTION	REMARK

UNLESS OTHERWISE,
GENERAL TOLERANCE:

X.xxx ±0.05
X.xx ±0.15
X.x ±0.20
X. ±0.38

ANGULAR:

X.xx ±1°
X.x ±3°
X. ±5°

东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

TITLE:

Ø3.5mm Phone Jack CONN.

客户图

THIRD ANGLE PROJECTION



UNIT:

mm

P/N:

XB-J441J06JA26XL2

MODEL:

J441-26

DRAW NO.:

SCALE:

1:1

SIZE:

A4

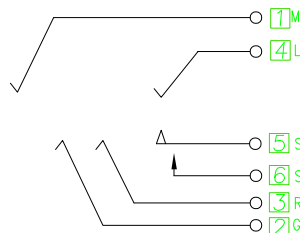
SHEET:

1/1

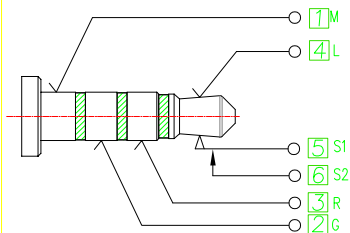
PLUG SPEC

5.50 2.50 3-0.7 8.5 14.00 0.350±0.05 0.250±0.05 0.300±0.05 0.320±0.05

SCHEMATIC



AFTER INSERT SCHEMATIC



DESIGN

钟凯

2018.10.22

CHECK

殷芳祥

2018.10.22

APPROVAL

殷芳祥

2018.10.22

N/A

A

新版发行

2018.10.22

钟凯

ECN NO.

REV.

DESCRIPTION

DATE

CHANGE

APPROVAL

殷芳祥

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